

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
200V	48mΩ@10V	52A

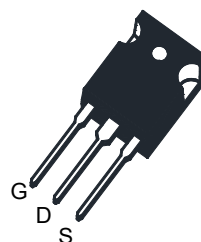
Feature

- Advanced Planar Power MOSFET
- Low $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

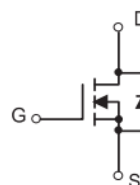
Application

- Power Switching Application
- DC/DC Converter

TO-247-3L



Schematic diagram



Package Marking and Ordering Information

Part Number	Package	Marking	Packing	Reel Size	Tape Width	Qty
GP52N20TD	TO-247-3L	52N20	Tube	NA	NA	30pcs

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain - Source Voltage		V_{DS}	200	V
Gate - Source Voltage		V_{GS}	±30	V
Continuous Drain Current ¹	$T_C = 25^\circ\text{C}$	I_D	52	A
	$T_C = 100^\circ\text{C}$	I_D	33	A
Pulsed Drain Current ²		I_{DM}	208	A
Single Pulsed Avalanche Current ³		I_{AS}	60	A
Single Pulsed Avalanche Energy ³		E_{AS}	900	mJ
Power Dissipation ⁵		P_D	208	W
Thermal Resistance from Junction to Ambient ⁶		$R_{\theta JA}$	69	$^\circ\text{C/W}$
Thermal Resistance from Junction to Case		$R_{\theta JC}$	0.6	$^\circ\text{C/W}$
Junction Temperature		T_J	150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55~ +150	$^\circ\text{C}$

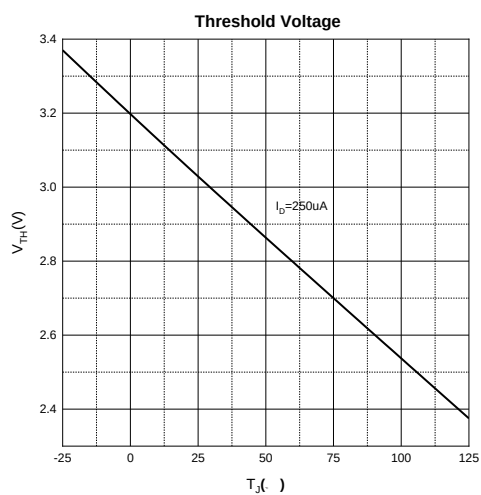
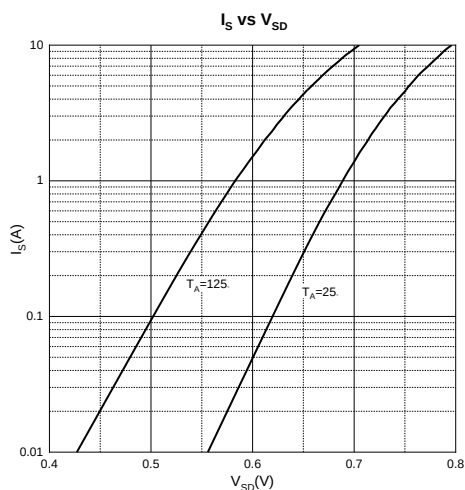
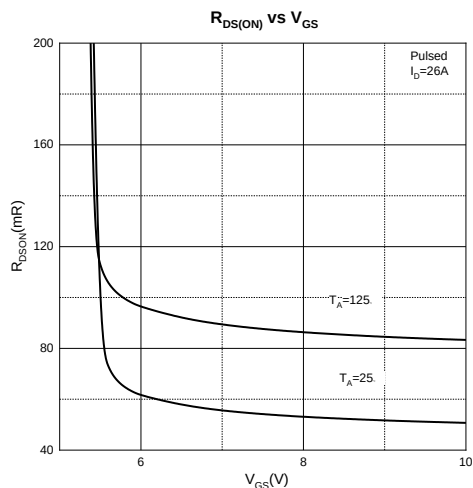
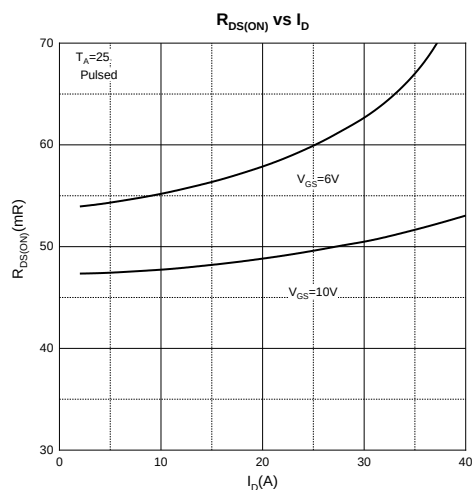
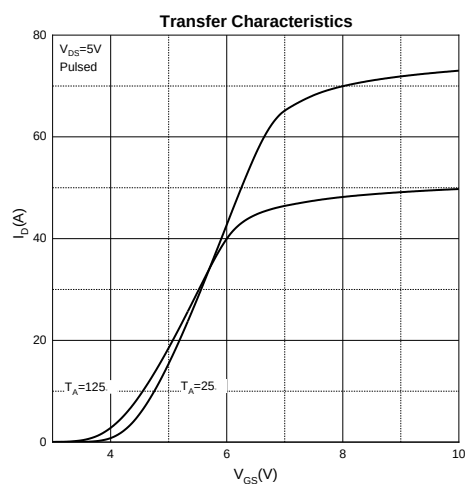
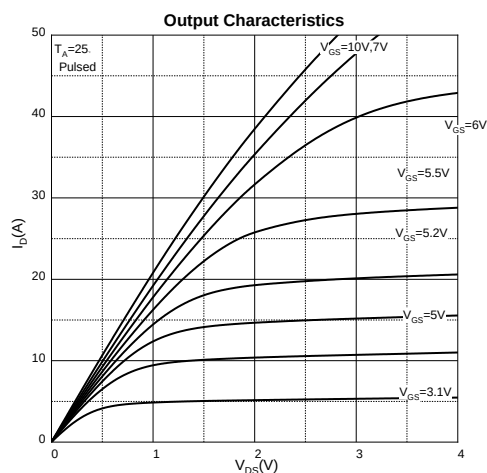
MOSFET ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

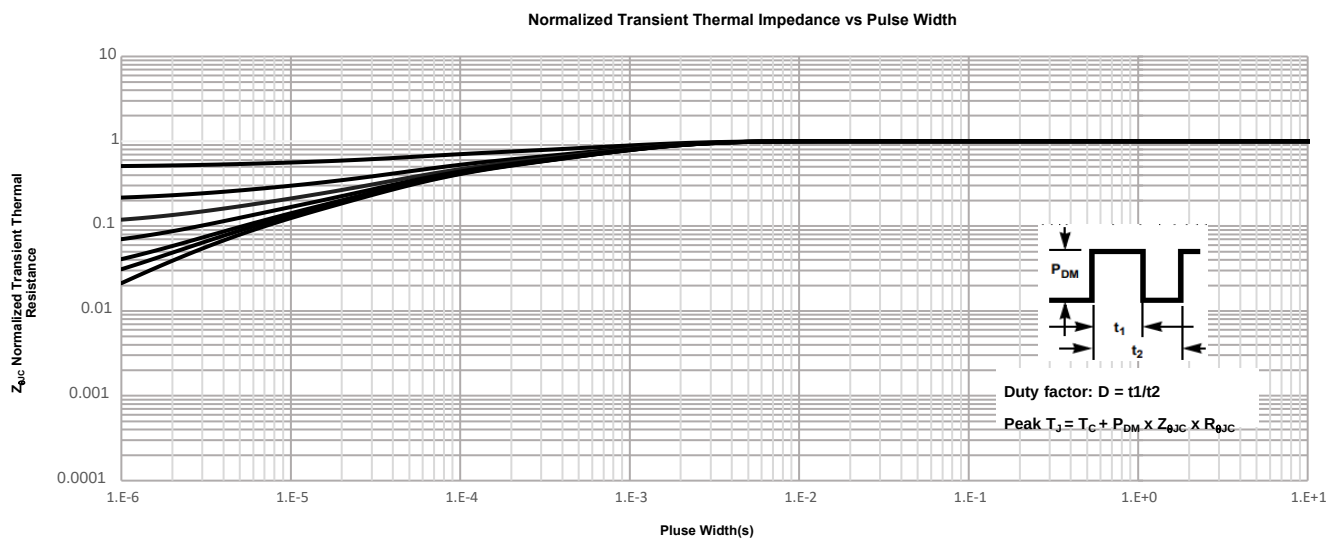
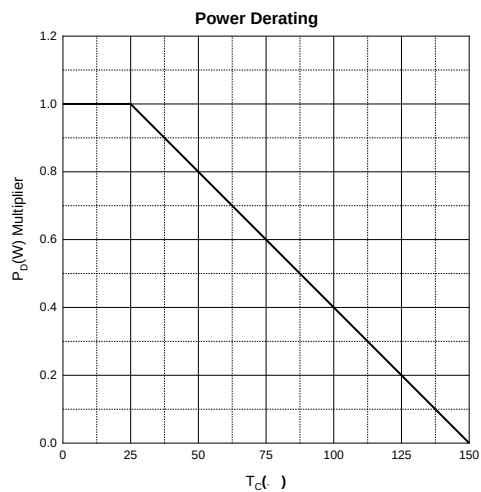
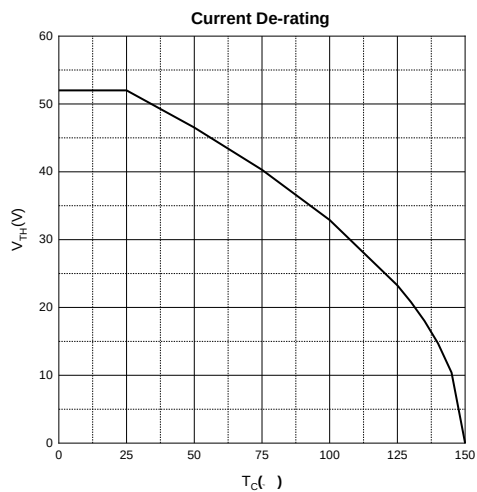
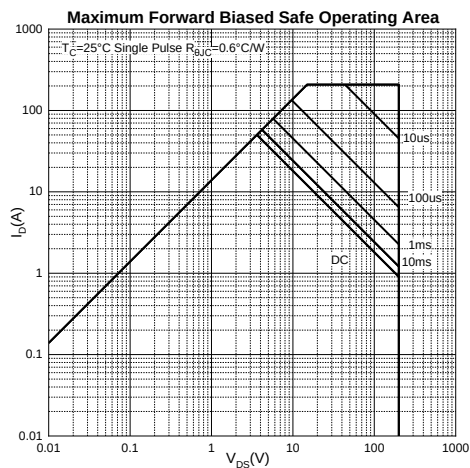
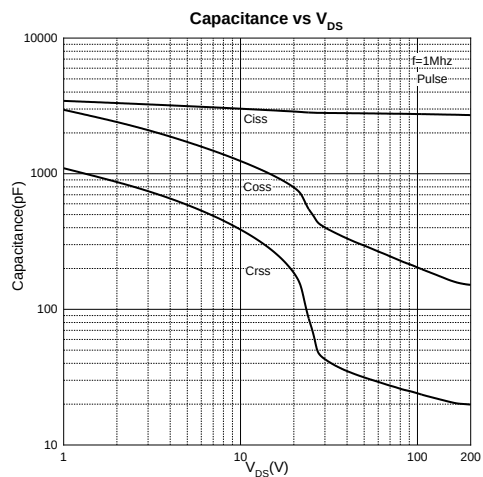
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	200			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 200V, V_{GS} = 0V$			1	μA
Gate - Body Leakage Current	I_{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$			± 100	nA
On Characteristics ⁴						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	3	3.7	V
Drain-source On-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 30A$		48	65	m Ω
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 100V, V_{GS} = 0V, f = 1MHz$		2752		pF
Output Capacitance	C_{oss}			204		
Reverse Transfer Capacitance	C_{rss}			24		
Gate Resistance	R_g	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$		1.8		Ω
Switching Characteristics						
Total Gate Charge	Q_g	$V_{DS} = 100V, V_{GS} = 10V, I_D = 26A$		64.6		nC
Gate-source Charge	Q_{gs}			15.5		
Gate-drain Charge	Q_{gd}			21.1		
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 100V, V_{GS} = 10V, I_D = 52A,$ $R_G = 24\Omega$		30		ns
Turn-on Rise Time	t_r			120		
Turn-off Delay Time	$t_{d(off)}$			140		
Turn-off Fall Time	t_f			110		
Source - Drain Diode Characteristics						
Diode Forward Voltage ⁴	V_{SD}	$V_{GS} = 0V, I_S = 26A$			1.2	V

Notes :

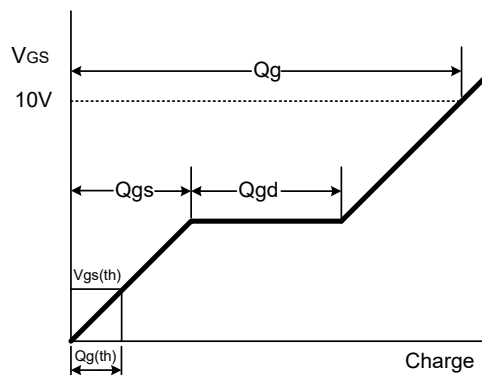
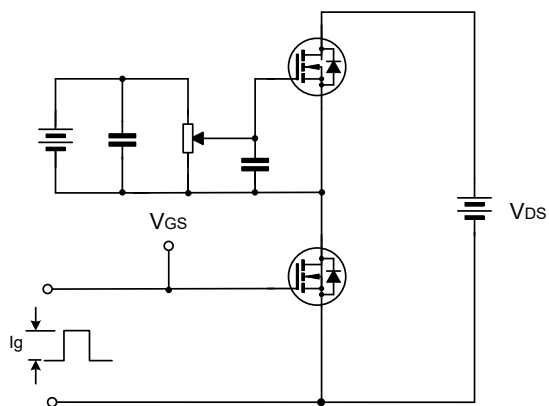
- 1.The maximum current rating is limited by package.And device mounted on a large heatsink
- 2.Pulse Test : Pulse Width $\leq 10\mu s$, duty cycle $\leq 1\%$.
- 3.EAS condition: $V_{DD} = 50V, V_{GS} = 10V, L = 0.5mH, R_G = 25\Omega$ Starting $T_J = 25^\circ\text{C}$.
- 4.Pulse Test : Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.
- 5.The power dissipation P_D is limited by $T_{J(MAX)} = 150^\circ\text{C}$.And device mounted on a large heatsink
- 6.Device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

Typical Characteristics

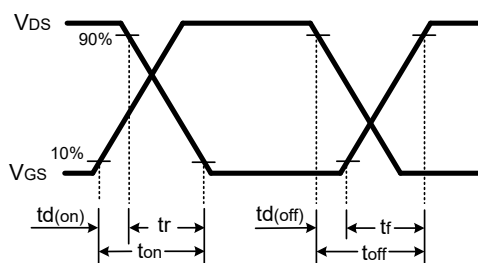
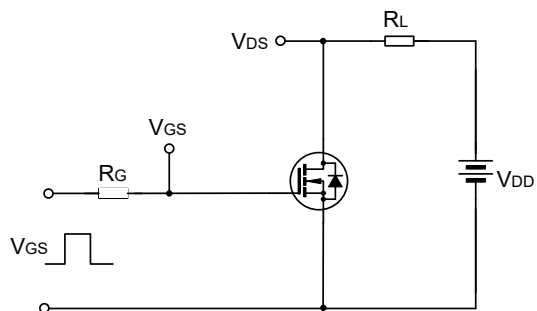




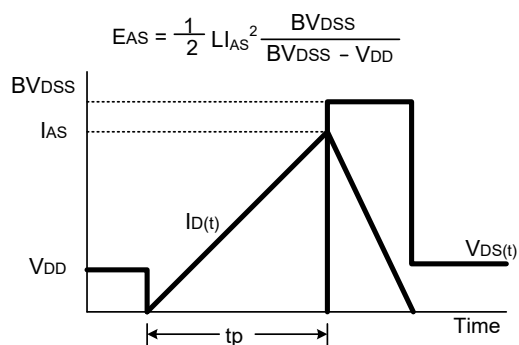
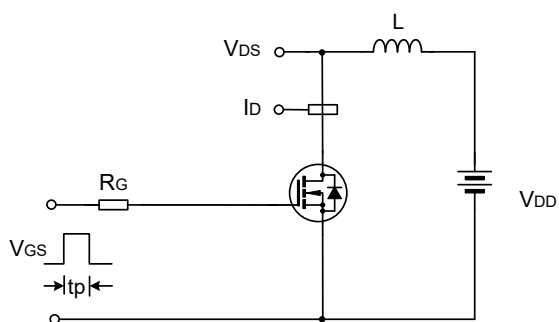
Gate Charge Test Circuit & Waveform

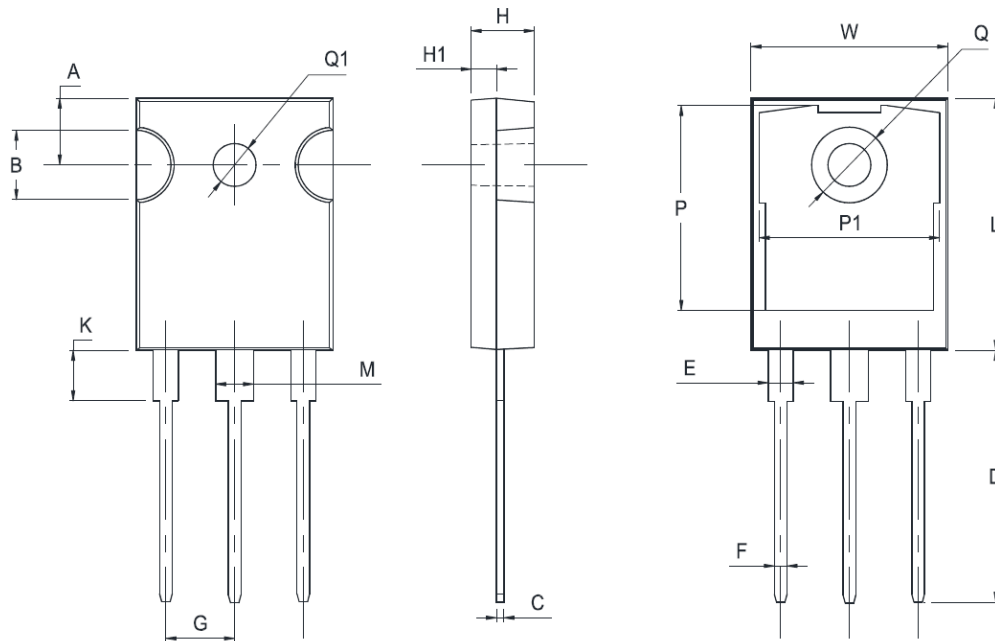


Resistive Switching Test Circuit & Waveform



E_{AS} Test Circuit & Waveform



TO-247-3L Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	5.900	6.500	0.232	0.256
B	4.600	5.200	0.181	0.205
C	0.500	0.700	0.020	0.028
D	19.700	20.300	0.776	0.799
E	1.800	2.200	0.071	0.087
F	1.100	1.300	0.043	0.051
G	5.100	5.700	0.201	0.224
W	15.800	16.200	0.622	0.638
H	4.700	5.300	0.185	0.209
H1	2.100	2.500	0.083	0.098
K	4.050	4.450	0.159	0.175
L	20.700	21.300	0.815	0.839
M	2.800	3.200	0.110	0.126
P	16.200	16.600	0.638	0.654
P1	13.800	14.200	0.543	0.559
Q	7.050	7.350	0.278	0.289
Q1	3.600	4.200	0.142	0.165

Attention:

- GreenPower Electronics reserves the right to improve product design function and reliability without notice.
- Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.
- GreenPower Electronics products belong to consumer electronics or other civilian electronic products.